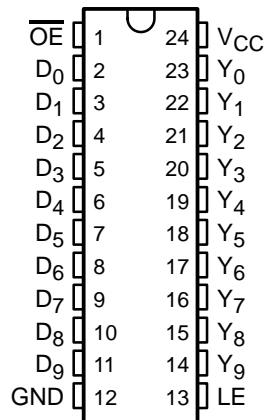


# CY54FCT841T, CY74FCT841T 10-BIT LATCHES WITH 3-STATE OUTPUTS

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- Function, Pinout, and Drive Compatible With FCT, F, and AM29841 Logic
- Reduced  $V_{OH}$  (Typically = 3.3 V) Versions of Equivalent FCT Functions
- Edge-Rate Control Circuitry for Significantly Improved Noise Characteristics
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Matched Rise and Fall Times
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)
- Fully Compatible With TTL Input and Output Logic Levels
- High-Speed Parallel Latches
- Buffered Common Latch-Enable Input
- 3-State Outputs
- CY54FCT841T
  - 32-mA Output Sink Current
  - 12-mA Output Source Current
- CY74FCT841T
  - 64-mA Output Sink Current
  - 32-mA Output Source Current

CY54FCT841T . . . D PACKAGE  
CY74FCT841T . . . P, Q, OR SO PACKAGE  
(TOP VIEW)



## description

The 'FCT841T bus-interface latches are designed to eliminate additional packages required to buffer existing latches and provide additional data width for wider address/data paths or buses carrying parity. The 'FCT841T devices are buffered 10-bit-wide versions of the FCT373 function.

The 'FCT841T devices' high-performance interface is designed for high-capacitance-load drive capability, while providing low-capacitance bus loading at both inputs and outputs. Outputs are designed for low-capacitance bus loading in the high-impedance state.

These devices are fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

### PIN DESCRIPTION

NAME	I/O	DESCRIPTION
D	I	Latch data inputs
LE	I	Latch-enable input. The latches are transparent when LE is high. Input data is latched on the high-to-low transition.
Y	O	3-state latch outputs
$\overline{OE}$	I	Output-enable control. When $\overline{OE}$ is low, the outputs are enabled. When $\overline{OE}$ is high, the outputs are in the high-impedance (off) state.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

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ORDERING INFORMATION

T <sub>A</sub>	PACKAGE†		SPEED (ns)	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	QSOP – Q	Tape and reel	5.5	CY74FCT841CTQCT	FCT841C
	SOIC – SO	Tube	5.5	CY74FCT841CTSOC	FCT841C
		Tape and reel	5.5	CY74FCT841CTSOCT	
	DIP – P	Tube	6.5	CY74FCT841BTPC	CY74FCT841BTPC
	SOIC – SO	Tube	9	CY74FCT841ATSOC	FCT841A
		Tape and reel	9	CY74FCT841ATSOCT	
–55°C to 125°C	CDIP – D	Tube	10	CY54FCT841ATDMB	

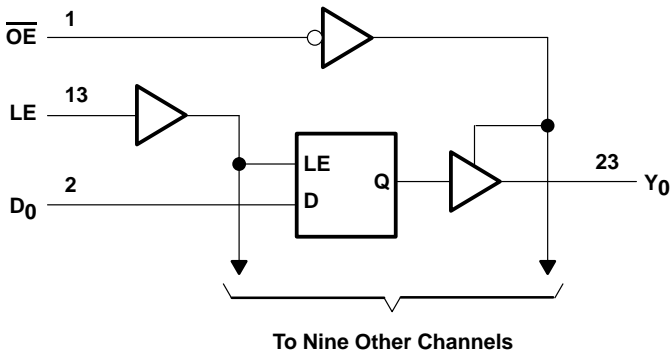
† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

FUNCTION TABLE

INPUTS			INTERNAL OUTPUTS		FUNCTION
$\overline{OE}$	LE	D	O	Y	
H	X	X	X	Z	Z
H	H	L	L	Z	
H	H	H	H	Z	
H	L	X	NC	Z	Latched (Z)
L	H	L	L	L	Transparent
L	H	H	H	H	
L	L	X	NC	NC	Latched

H = High logic level, L = Low logic level, X = Don't care, NC = No change, Z = High-impedance state

logic diagram (positive logic)



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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage range to ground potential	–0.5 V to 7 V
DC input voltage range	–0.5 V to 7 V
DC output voltage range	–0.5 V to 7 V
DC output current (maximum sink current/pin)	120 mA
Package thermal impedance, $\theta_{JA}$ (see Note 1): P package	67°C/W
(see Note 2): Q package	61°C/W
(see Note 2): SO package	46°C/W
Ambient temperature range with power applied, $T_A$	–65°C to 135°C
Storage temperature range, $T_{stg}$	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The package thermal impedance is calculated in accordance with JESD 51-3.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

**recommended operating conditions (see Note 3)**

	CY54FCT841T			CY74FCT841T			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
$V_{CC}$ Supply voltage	4.5	5	5.5	4.75	5	5.25	V
$V_{IH}$ High-level input voltage	2			2			V
$V_{IL}$ Low-level input voltage			0.8			0.8	V
$I_{OH}$ High-level output current			–12			–32	mA
$I_{OL}$ Low-level output current			32			64	mA
$T_A$ Operating free-air temperature	–55		125	–40		85	°C

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation.

# CY54FCT841T, CY74FCT841T

## 10-BIT LATCHES

### WITH 3-STATE OUTPUTS

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	CY54FCT841T			CY74FCT841T			UNIT
		MIN	TYP†	MAX	MIN	TYP†	MAX	
$V_{IK}$	$V_{CC} = 4.5 \text{ V}$ , $I_{IN} = -18 \text{ mA}$	-0.7	-1.2					V
	$V_{CC} = 4.75 \text{ V}$ , $I_{IN} = -18 \text{ mA}$				-0.7	-1.2		
$V_{OH}$	$V_{CC} = 4.5 \text{ V}$ , $I_{OH} = -12 \text{ mA}$	2.4	3.3					V
	$V_{CC} = 4.75 \text{ V}$ , $I_{OH} = -32 \text{ mA}$				2			
	$I_{OH} = -15 \text{ mA}$				2.4	3.3		
$V_{OL}$	$V_{CC} = 4.5 \text{ V}$ , $I_{OL} = 32 \text{ mA}$	0.3	0.55					V
	$V_{CC} = 4.75 \text{ V}$ , $I_{OL} = 64 \text{ mA}$				0.3	0.55		
$V_{hys}$	All inputs	0.2			0.2			V
$I_I$	$V_{CC} = 5.5 \text{ V}$ , $V_{IN} = V_{CC}$			5				$\mu\text{A}$
	$V_{CC} = 5.25 \text{ V}$ , $V_{IN} = V_{CC}$						5	
$I_{IH}$	$V_{CC} = 5.5 \text{ V}$ , $V_{IN} = 2.7 \text{ V}$			$\pm 1$				$\mu\text{A}$
	$V_{CC} = 5.25 \text{ V}$ , $V_{IN} = 2.7 \text{ V}$						$\pm 1$	
$I_{IL}$	$V_{CC} = 5.5 \text{ V}$ , $V_{IN} = 0.5 \text{ V}$			$\pm 1$				$\mu\text{A}$
	$V_{CC} = 5.25 \text{ V}$ , $V_{IN} = 0.5 \text{ V}$						$\pm 1$	
$I_{OZH}$	$V_{CC} = 5.5 \text{ V}$ , $V_{OUT} = 2.7 \text{ V}$			10				$\mu\text{A}$
	$V_{CC} = 5.25 \text{ V}$ , $V_{OUT} = 2.7 \text{ V}$						10	
$I_{OZL}$	$V_{CC} = 5.5 \text{ V}$ , $V_{OUT} = 0.5 \text{ V}$			-10				$\mu\text{A}$
	$V_{CC} = 5.25 \text{ V}$ , $V_{OUT} = 0.5 \text{ V}$						-10	
$I_{OS}^\ddagger$	$V_{CC} = 5.5 \text{ V}$ , $V_{OUT} = 0 \text{ V}$	-60	-120	-225				mA
	$V_{CC} = 5.25 \text{ V}$ , $V_{OUT} = 0 \text{ V}$				-60	-120	-225	
$I_{off}$	$V_{CC} = 0 \text{ V}$ , $V_{OUT} = 4.5 \text{ V}$			$\pm 1$			$\pm 1$	$\mu\text{A}$
$I_{CC}$	$V_{CC} = 5.5 \text{ V}$ , $V_{IN} \leq 0.2 \text{ V}$ , $V_{IN} \geq V_{CC} - 0.2 \text{ V}$	0.1	0.2					mA
	$V_{CC} = 5.25 \text{ V}$ , $V_{IN} \leq 0.2 \text{ V}$ , $V_{IN} \geq V_{CC} - 0.2 \text{ V}$				0.1	0.2		
$\Delta I_{CC}$	$V_{CC} = 5.5 \text{ V}$ , $V_{IN} = 3.4 \text{ V}^\S$ , $f_1 = 0$ , Outputs open	0.5	2					mA
	$V_{CC} = 5.25 \text{ V}$ , $V_{IN} = 3.4 \text{ V}^\S$ , $f_1 = 0$ , Outputs open				0.5	2		
$I_{CCD}^\P$	$V_{CC} = 5.5 \text{ V}$ , One input switching at 50% duty cycle, Outputs open, $\overline{OE} = \text{GND}$ , $LE = V_{CC}$ , $V_{IN} \leq 0.2 \text{ V}$ or $V_{IN} \geq V_{CC} - 0.2 \text{ V}$	0.06	0.12					mA/MHz
	$V_{CC} = 5.25 \text{ V}$ , One input switching at 50% duty cycle, Outputs open, $\overline{OE} = \text{GND}$ , $LE = V_{CC}$ , $V_{IN} \leq 0.2 \text{ V}$ or $V_{IN} \geq V_{CC} - 0.2 \text{ V}$				0.06	0.12		

† Typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests,  $I_{OS}$  tests should be performed last.

§ Per TTL-driven input ( $V_{IN} = 3.4 \text{ V}$ ); all other inputs at  $V_{CC}$  or GND

¶ This parameter is derived for use in total power-supply calculations.

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**10-BIT LATCHES**  
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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)**

PARAMETER	TEST CONDITIONS			CY54FCT841T		CY74FCT841T			UNIT
				MIN	TYP†	MAX	MIN	TYP†	
I <sub>C</sub> <sup>#</sup>	V <sub>CC</sub> = 5.5 V, Outputs open, OE = GND, LE = V <sub>CC</sub>	One bit switching at f <sub>1</sub> = 10 MHz at 50% duty cycle	V <sub>IN</sub> ≤ 0.2 V or V <sub>IN</sub> ≥ V <sub>CC</sub> – 0.2 V	0.7	1.4				mA
			V <sub>IN</sub> = 3.4 V or GND	1	2.4				
		10 bits switching at f <sub>1</sub> = 2.5 MHz at 50% duty cycle	V <sub>IN</sub> ≤ 0.2 V or V <sub>IN</sub> ≥ V <sub>CC</sub> – 0.2 V	1	3.2				
			V <sub>IN</sub> = 3.4 V or GND	4.1	13.2				
	V <sub>CC</sub> = 5.25 V, Outputs open, OE = GND, LE = V <sub>CC</sub>	One bit switching at f <sub>1</sub> = 10 MHz at 50% duty cycle	V <sub>IN</sub> ≤ 0.2 V or V <sub>IN</sub> ≥ V <sub>CC</sub> – 0.2 V				0.7	1.4	
			V <sub>IN</sub> = 3.4 V or GND				1	2.4	
		10 bits switching at f <sub>1</sub> = 2.5 MHz at 50% duty cycle	V <sub>IN</sub> ≤ 0.2 V or V <sub>IN</sub> ≥ V <sub>CC</sub> – 0.2 V				1	3.2	
			V <sub>IN</sub> = 3.4 V or GND				4.1	13.2	
C <sub>i</sub>				5	10		5	10	pF
C <sub>o</sub>				9	12		9	12	pF

† Typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

#  $I_C = I_{CC} + \Delta I_{CC} \times D_H \times N_T + I_{CCD} (f_0/2 + f_1 \times N_1)$

Where:

$I_C$  = Total supply current

$I_{CC}$  = Power-supply current with CMOS input levels

$\Delta I_{CC}$  = Power-supply current for a TTL high input ( $V_{IN} = 3.4\text{ V}$ )

$D_H$  = Duty cycle for TTL inputs high

$N_T$  = Number of TTL inputs at  $D_H$

$I_{CCD}$  = Dynamic current caused by an input transition pair (HLH or LHL)

$f_0$  = Clock frequency for registered devices, otherwise zero

$f_1$  = Input signal frequency

$N_1$  = Number of inputs changing at  $f_1$

All currents are in milliamperes and all frequencies are in megahertz.

|| Values for these conditions are examples of the  $I_{CC}$  formula.

**timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)**

		CY54FCT841AT		CY74FCT841AT		CY74FCT841BT		CY74FCT841CT		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
$t_w$	Pulse duration, LE high	5		4		4		4		ns
$t_{su}$	Setup time, data before $LE\uparrow$	2.5		2.5		2.5		2.5		ns
$t_h$	Hold time, data after $LE\uparrow$	3		2.5		2.5		2.5		ns



# CY54FCT841T, CY74FCT841T

## 10-BIT LATCHES

### WITH 3-STATE OUTPUTS

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#### switching characteristics over operating free-air temperature range (see Figure 1)

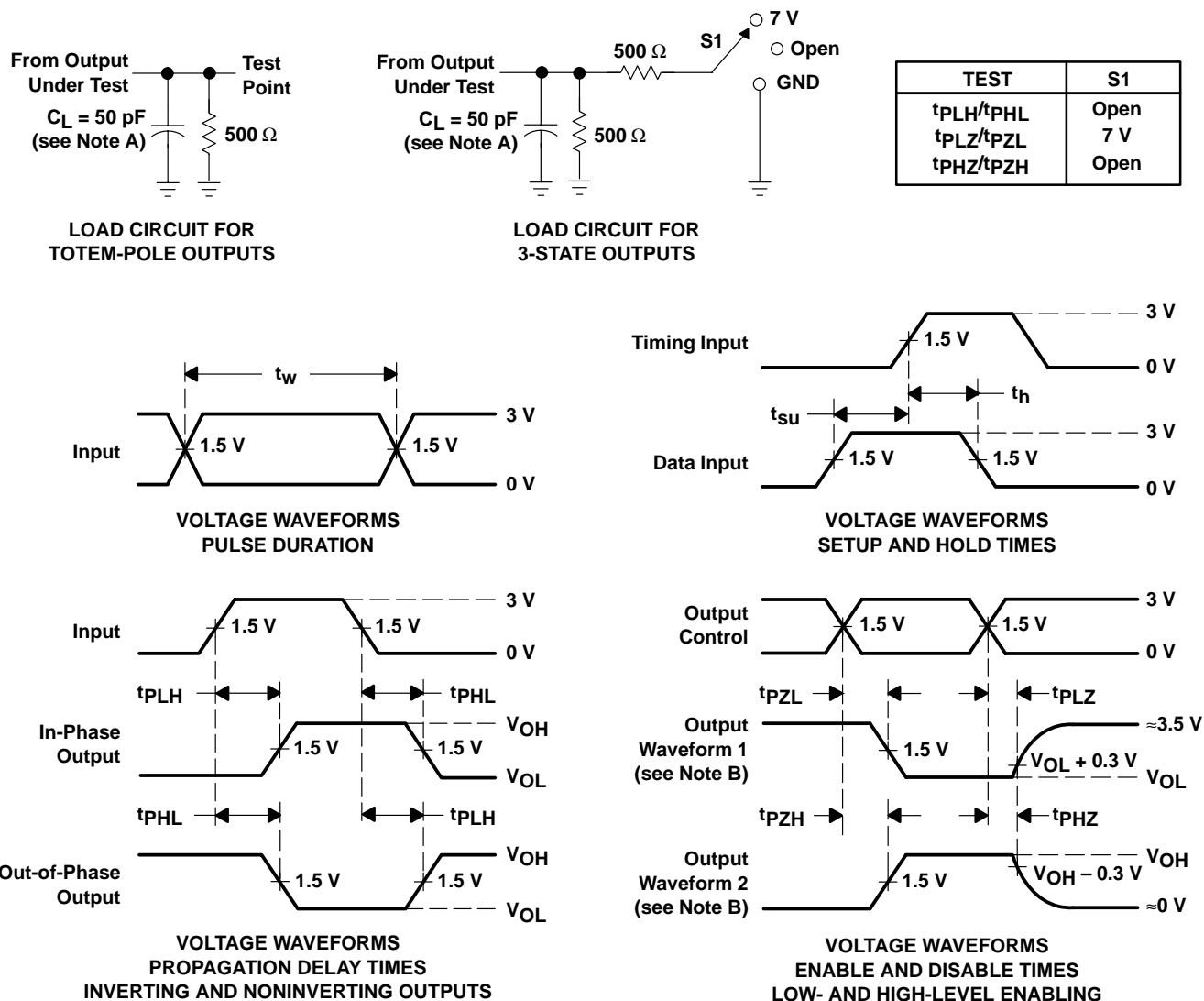
PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST LOAD	CY54FCT841AT		CY74FCT841AT		UNIT
				MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	D	Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	1.5	10	1.5	9	ns
t <sub>PHL</sub>				1.5	10	1.5	9	
t <sub>PLH</sub>	D	Y	C <sub>L</sub> = 300 pF, R <sub>L</sub> = 500 Ω	1.5	15	1.5	13	ns
t <sub>PHL</sub>				1.5	15	1.5	13	
t <sub>PLH</sub>	LE	Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	1.5	13	1.5	12	ns
t <sub>PHL</sub>				1.5	13	1.5	12	
t <sub>PLH</sub>	LE	Y	C <sub>L</sub> = 300 pF, R <sub>L</sub> = 500 Ω	1.5	20	1.5	16	ns
t <sub>PHL</sub>				1.5	20	1.5	16	
t <sub>PZH</sub>	$\overline{OE}$	Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	1.5	13	1.5	11.5	ns
t <sub>PZL</sub>				1.5	13	1.5	11.5	
t <sub>PZH</sub>	$\overline{OE}$	Y	C <sub>L</sub> = 300 pF, R <sub>L</sub> = 500 Ω	1.5	25	1.5	23	ns
t <sub>PZL</sub>				1.5	25	1.5	23	
t <sub>PHZ</sub>	$\overline{OE}$	Y	C <sub>L</sub> = 5 pF, R <sub>L</sub> = 500 Ω	1.5	9	1.5	7	ns
t <sub>PLZ</sub>				1.5	9	1.5	7	
t <sub>PHZ</sub>	$\overline{OE}$	Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	1.5	10	1.5	8	ns
t <sub>PLZ</sub>				1.5	10	1.5	8	

#### switching characteristics over operating free-air temperature range (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST LOAD	CY74FCT841BT		CY74FCT841CT		UNIT
				MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	D	Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	1.5	6.5	1.5	5.5	ns
t <sub>PHL</sub>				1.5	6.5	1.5	5.5	
t <sub>PLH</sub>	D	Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	1.5	13	1.5	13	ns
t <sub>PHL</sub>				1.5	13	1.5	13	
t <sub>PLH</sub>	LE	Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	1.5	8	1.5	6.4	ns
t <sub>PHL</sub>				1.5	8	1.5	6.4	
t <sub>PLH</sub>	LE	Y	C <sub>L</sub> = 300 pF, R <sub>L</sub> = 500 Ω	1.5	15.5	1.5	15	ns
t <sub>PHL</sub>				1.5	15.5	1.5	15	
t <sub>PZH</sub>	$\overline{OE}$	Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	1.5	8	1.5	6.5	ns
t <sub>PZL</sub>				1.5	8	1.5	6.5	
t <sub>PZH</sub>	$\overline{OE}$	Y	C <sub>L</sub> = 300 pF, R <sub>L</sub> = 500 Ω	1.5	14	1.5	12	ns
t <sub>PZL</sub>				1.5	14	1.5	12	
t <sub>PHZ</sub>	$\overline{OE}$	Y	C <sub>L</sub> = 5 pF, R <sub>L</sub> = 500 Ω	1.5	6	1.5	5.7	ns
t <sub>PLZ</sub>				1.5	6	1.5	5.7	
t <sub>PHZ</sub>	$\overline{OE}$	Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	1.5	7	1.5	6	ns
t <sub>PLZ</sub>				1.5	7	1.5	6	



## PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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